

98426-YXX-XX-XXXLF

PLATING

- G : 0.76 GXT
2μm MIN MATTE TIN ON TAIL
- S : 0.38 GXT
2μm MIN MATTE TIN ON TAIL
- F : GOLD FLASH /2μm MIN TIN ON TAIL
- T : 2μm MIN FULL TIN
1.27μm NICKEL MIN UNDERPLATING

LEAD FREE AND RoHS
COMPATIBLE, NOTE 6
BODY HEIGHT : XXX
- MIN= 104 (10.4MM)
- MAX= 290 (29.0MM)

PACKAGING, NOTE 3

NO. OF POS PER ROW, 03 TO 25

NOTES:

- MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM (SHROUD)
AND BLACK(UNSHROUDED)
- MATERIAL TERMINAL: COPPER ALLOY
- PACKAGING
- = STANDARD PACKAGING IN BLIBOX
S = CUSTOM PACKAGING IN TUBE
ONLY FOR PIN STYLE 17, NOTE 7
- SHROUDED RETENTION FORCE 3N MIN PER POSITION
- 0.3 MAX PROTRUSION FOR -03 TO 11
- RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE,
2μm MINIMUM MATTE TIN OVER 1.27μm
MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C ±5°C SOLDER BATH TEMPERATURE FOR
5 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.6mm MIN THICK CIRCUIT BOARD.

c - LABELING:

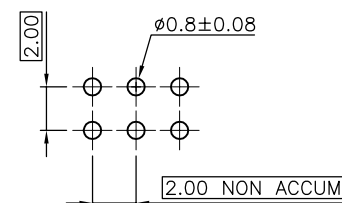
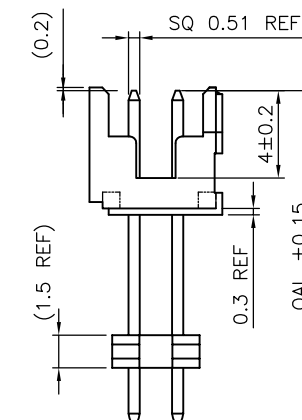
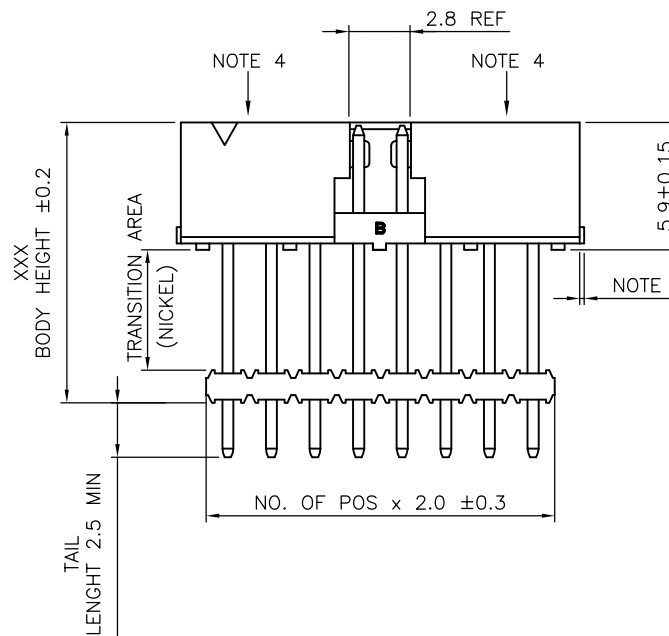
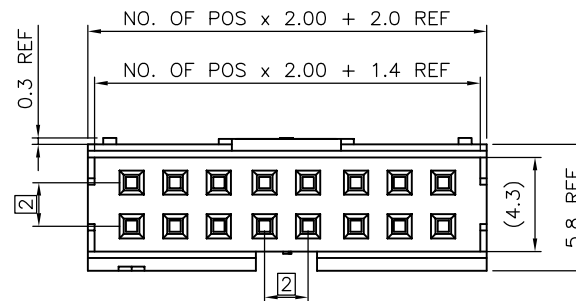
- MEETS PACKAGING SPECS AS PER GS-14-920

d - LEGAL STATEMENT: SEE GS-47-0004

6 - THIS PRODUCT IS NOT INTENDED TO BE USED THROUGH REFLOW PROCESS

7 - CUSTOM SPECIAL WITH "OAL" 11.8mm AND BODY HEIGHT 8.8mm

PIN STYLE	OAL
01	12.8
02	13.5
03	14.1
04	15.6
05	16.3
06	17.1
07	18.3
08	19.1
09	20.3
10	21.1
11	22.3
12	23.3
13	26.0
14	28.0
15	30.0
16	32.0
17	NOTE 7



RECOMMENDED HOLE PATTERN

mat'l. code				surface	tolerance	projection	product family	
				ISO 1302	ISO 406	ISO 101	MINITEK	
ltr	ecn no	dr	date	tolerances unless otherwise specified		mm	title	
A	F09-0227	JCO	09.12.07	angles	X.X ±0.3		SHR STACKING	
B	F10-0067	JCO	10.06.29	linear	X.XX ±0.13	scale 1:1	HEADER MINITEK	
C	B-18972	LMU	14.10.01		X.XXX ±0.05		dwg no	
D	B-19190	LMU	14.10.24	dr	L.MULIN	FCJ	sheet 1 of 1	
E	B-20291	BVE	15.02.19	engr	J.COMPAGNON		size	
				chr	JCO		98426	
				appd	J.CO		A3	
sheet index		revision sheet				type		CUSTOMER Drawing